

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5687609

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MICHAEL QUINLAN	10/09/2018
RECEIVING PARTY DATA	
Name:	S&C ELECTRIC COMPANY
Street Address:	6601 N. RIDGE BLVD.
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60626
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16551814
CORRESPONDENCE DATA	
Fax Number:	(773)338-8081
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	773-338-1000
Email:	satoko.nakao@sandc.com
Correspondent Name:	ANTHONY G. SITKO
Address Line 1:	6601 N. RIDGE BLVD.
Address Line 4:	CHICAGO, ILLINOIS 60626
ATTORNEY DOCKET NUMBER:	SC-5500
NAME OF SUBMITTER:	ANTHONY G. SITKO
SIGNATURE:	/Anthony G. Sitko, 36278/
DATE SIGNED:	08/27/2019
Total Attachments: 1	
source=SC-5500_Assignment#page1.tif	

ASSIGNMENT

Serial No: 62/743,186

Filed: October 9, 2018

Title: SOLAR GENERATION ESTIMATION

For \$10.00 (Ten Dollars) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assigns S&C Electric Company having a place of business at 6601 North Ridge Boulevard, Chicago, Illinois 60626, United States of America (hereinafter "Assignee"), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in an application for letters patent of the United States, filed by the undersigned on October 9, 2018 as application serial No. 62/743,186 and in said application and any and all other applications, both in the United States and in other countries, which the undersigned may file or be named as an inventor, either solely or jointly with others on said invention or improvements and in any and all letters patent of the United States and other countries, which may be obtained on any said applications, and in any reissue or extension thereof.

The undersigned hereby authorizes and request the issuance of said letters patent to said Assignee.

The undersigned warrants himself to be the owner of the interest herein assigned and to have the right to make this assignment and further warrants that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned except in favor of Assignee.

For said consideration the undersigned hereby agrees, upon the request and at the expense of said Assignee, its successors and assigns, to execute any and all applications on said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any letters patent that may be granted upon any and all of said applications, and any and all applications and other documents for letters patent in other countries on said invention or improvements, that said Assignee, its successors or assigns, may deem necessary or expedient, and for said consideration the undersigned further agree upon the request of said Assignee, its successors or assigns, in the event of any application or letters patent assigned herein becoming involved in Interference or Opposition, to cooperate to the best of the ability of the undersigned with said Assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform, upon request, any and all affirmative acts to obtain said letters patent in all countries, and vest all rights therein hereby conveyed in said Assignee, its successors and assigns, whereby said letters patent will be held and enjoyed by said Assignee, its successors and assigns, to the full end of the term for which said letters patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

Date: 10/09/2018By: Michael Quinlan
Michael Quinlan